

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT										
NATURE OF CONVEYANCE:	Corrective Assignment to correct the spelling of the third inventor's middle name to "IL" instead of "II" previously recorded on Reel 024083 Frame 0268. Assignor (s) hereby confirms the third inventor's name is Moon II LEE.										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Bin Chul IHM</td> <td>02/05/2010</td> </tr> <tr> <td>Wook Bong LEE</td> <td>02/05/2010</td> </tr> <tr> <td>Moon II LEE</td> <td>02/05/2010</td> </tr> <tr> <td>Jin Young CHUN</td> <td>02/05/2010</td> </tr> </tbody> </table>		Name	Execution Date	Bin Chul IHM	02/05/2010	Wook Bong LEE	02/05/2010	Moon II LEE	02/05/2010	Jin Young CHUN	02/05/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>LG ELECTRONICS INC.</td> </tr> <tr> <td>Street Address:</td> <td>20 Yeouido-dong, Yeongdeungpo-gu</td> </tr> <tr> <td>City:</td> <td>Seoul</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> <tr> <td>Postal Code:</td> <td>150-721</td> </tr> </table>		Name:	LG ELECTRONICS INC.	Street Address:	20 Yeouido-dong, Yeongdeungpo-gu	City:	Seoul	State/Country:	REPUBLIC OF KOREA	Postal Code:	150-721
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CORRESPONDENCE DATA											
<p>Fax Number: (213)623-2211 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 213-623-2221 Email: patent@lhlaw.com Correspondent Name: LEE, HONG, DEGERMAN, KANG & WAIMEY Address Line 1: 660 S. FIGUEROA STREET Address Line 2: Suite 2300 Address Line 4: LOS ANGELES, CALIFORNIA 90017</p>											
ATTORNEY DOCKET NUMBER:	2101-3795C1										
NAME OF SUBMITTER:	Harry S. Lee										

CH \$40.00 12724318

501525778

REEL: 026251 FRAME: 0870

PATENT

Total Attachments: 4

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PATENT

REEL: 026251 FRAME: 0871

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
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NAME OF SUBMITTER:	Harry S. Lee										
Signature:	/Harry S. Lee/										
Date:	03/15/2010										

PATENT**REEL: 026251 FRAME: 0872**

Total Attachments: 2

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RECEIPT INFORMATION**EPAS ID:** PAT1141481**Receipt Date:** 03/15/2010**Fee Amount:** \$40**PATENT****REEL: 026251 FRAME: 0873**

ASSIGNMENT

(1-8) *Insert Name(s) of Inventor(s)*

- (1) IHM, Bin Chul (5)
- (2) LEE, Wook Bong (6)
- (3) LEE, Moon Il (7)
- (4) CHUN, Jin Young (8)

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) *Insert name of Assignee*

(9) **LG ELECTRONICS INC.**

(10) *Insert state of Incorporation of Assignee*

(10) **Korea**

(11) *Insert address of Assignee*

(11) 20 YEOUIDO-DONG, YEONGDEUNGPO-GU, Seoul, 150-721, Korea

(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as

(12) *Insert identification of Invention, such as Title, Case Number or Foreign Application Number*

(12) **DATA TRANSMITTING AND RECEIVING METHOD USING PHASE SHIFT BASED PRECODING AND TRANSCEIVER SUPPORTING THE SAME**

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.

(13) *Insert Date of Signing of Application*

(13)

1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

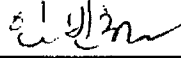
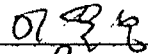
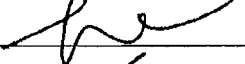
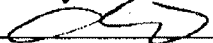
2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby appoints **the Attorneys associated with Customer No. 035884** the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>5th Feb, 2010</u>	Signature of Inventor <u></u>
Date: <u>8th Feb 2010</u>	Signature of Inventor <u></u>
Date: <u>5th Feb. 2010</u>	Signature of Inventor <u></u>
Date: <u>7th Feb, 2010</u>	Signature of Inventor <u></u>
Date: _____	Signature of Inventor _____
Date: _____	Signature of Inventor _____
Date: _____	Signature of Inventor _____
Date: _____	Signature of Inventor _____



LG Electronics